



Product Overview

Focus Tech ME-560

Copper Microetch

Product Description

ME-560 is a potassium monopersulfate based microetch. ME-560 provides superior surface topography and extended bath life when compared to generic sodium persulfate microetch.

Physical Properties

Specific gravity: 1.1-1.4
Appearance: white, granular solid
Odor: none

Compatible Materials of Construction

Plastics	PVC, CPVC, PVDF, polypropylene and polyethylene
Metals and alloys	Titanium
Elastomers	EPDM, Viton and Buna-N

Bath Make-Up

30 – 120 g/L μ ETCH ME-560
2% v/v sulfuric acid
Balance DI water

Operating Parameters

Copper loading: 2 - 4 oz/gal (15 – 37.5 g/L)
Dwell time: 1 – 2 minutes
Temperature: 80 °F – 110 °F

Safety

Avoid contact with eyes, skin and clothing. Wear chemical handler's gloves, goggles and protective clothing when handling. Read and understand Material Safety Data Sheet before using this product.

Notice

The information and recommendations, contained herein, regarding this product are, to the best of our knowledge, true and accurate. We make no guarantee of results because the conditions of actual use are beyond our control. We assume no liability for damages or penalties resulting from the use of this product or following our recommendations. Our recommendations and suggestions for use of this product are not intended to grant license to operate under or infringe any patent.